## C- to X-Band GaN HEMT Low Noise Amplifier





## **Product Description**

*MECGANLNACX* is a 0.25µm GaN HEMT Low Noise Amplifier designed and tested by MEC for C- to X-Band applications.

In the frequency range from 5 GHz to 12 GHz MECGANLNACX provides at least 22dB of linear gain, less than 2 dB of noise figure and a P1dB of at least 18 dBm.

In addition to the high electrical performances, this GaN LNA is capable of working in safe operation up to 20÷27 dB of gain compression (26 dBm of CW overdrive power).

#### **Main Features**

- 0.25µm GaN HEMT Technology
- 5–12 GHz full performance Frequency Range
- Small Signal Gain > 21 dB
- Noise Figure: <1.8 (6 9 GHz)
- Noise Figure: <2.1 (5 12 GHz)
- P1dB > 18 dBm, Psat > 23 dBm
- Overdrive Pin: 25 dBm
- Bias: Vd = 10 ÷ 15V, Id = 90mA, Vg = -2.7V (Typ.)
- Chip Size: 3.00 x 1.35 x 0.10 mm<sup>3</sup>

#### **Typical Applications**

- Commercial and Military Radar
- Communications
- Test Instrumentation

# **Measured Data**







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# **Main Characteristics**

Parameter	Min	Тур	Max	Unit
Operating frequency	5		11	GHz
Small Signal Gain	22		24	dB
Noise Figure	1.5		2.0	dB
Input Return Loss		-9		dB
Output Return Loss		-9		dB
Output Power at 1 dB of Gain Compression		19.5		dBm
Output Power at Saturation		23		dBm
Overdrive Input Power (CW)			25	dBm
Overdrive Gain Compression Level			25	dB
Drain Supply Voltage		10		V
Supply Quiescent Drain Current		90		mA
DC Power Consumption		0.90		W
DC Power Consumption at 1 dB of Gain Compr.		1.50		W

#### Test Conditions: $T_{base_plate} = 25^{\circ}C$ , Vd = 15 V, Idq = 90 mA - CW

Parameter	Min	Тур	Max	Unit
Operating frequency	5		12.5	GHz
Small Signal Gain	22		27	dB
Noise Figure	1.5		2.1	dB
Input Return Loss		-8		dB
Output Return Loss		-5		dB
Output Power at 1 dB of Gain Compression		18		dBm
Output Power at Saturation		26		dBm
Overdrive Input Power (CW)			26	dBm
Overdrive Gain Compression Level			27	dB
Drain Supply Voltage		15		V
Supply Quiescent Drain Current		90		mA
DC Power Consumption		1.35		W
DC Power Consumption at 1 dB of Gain Compr.		1.95		W



#### Linear Gain, Noise Figure, Input and Output Return Loss









#### Linear Gain and Noise Figure over Quiescent Drain Current

Test Conditions:  $T_{base_plate} = 25^{\circ}C$ , Vd = 10 VIdq = 90mA - Idq = 112mA - Idq = 135mA









## Nonlinear Measurement: Output Power, Drain Current, Gain Compr.

Test Conditions:  $T_{base_plate} = 25^{\circ}C$ , Vd = 10 V, Idq = 90 mAFrequency: 5 GHz - 7 GHz - 9 GHz - 11 GHz





## Nonlinear Measurement: Output Power, Drain Current, Gain Compr.

Test Conditions:  $T_{base_plate} = 25^{\circ}C$ , Vd = 15 V, Idq = 90 mAFrequency: 6 GHz - 8 GHz - 10 GHz - 12 GHz





## Nonlinear Measurement: Output Power, Drain Current, Gain Compr.

Test Conditions:  $T_{base_plate} = 25^{\circ}C$ , Vd = 10 V, Idq = 90 mA

- Pout and Drain Current at Pin = -1 dBm (1 dB of Gain Compression)
- Pout and Drain Current at Pin = 5 dBm (4 dB of Gain Compression)
- Pout and Drain Current at Pin = 13 dBm (saturation)



Test Conditions:  $T_{base_plate} = 25^{\circ}C$ , Vd = 15 V, Idq = 90 mA

- Pout and Drain Current at Pin = -2 dBm (1 dB of Gain Compression)
- Pout and Drain Current at Pin = 4 dBm (4 dB of Gain Compression)
- Pout and Drain Current at Pin = 15 dBm (saturation)







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# **Bond Pad Configuration & Assembly Recommendations**





Eutectic Die bond using AuSn (80/20) solder is recommended.

The backside of the die is the Source (ground) contact.

Thermosonic ball or wedge bonding are the preferred connection methods.

Gold wire must be used for connections.

#### **Bias Procedure**

#### **Bias-Up**

- 1. Vg set to 5 V.
- 2. Vd set to  $+10 \div +15$  V.
- 3. Adjust Vg until quiescent Id is 90 mA (Vg = -2.7 V Typical).
- 4. Apply RF signal.

#### **Bias-Down**

- 1. Turn off RF signal.
- 2. Reduce Vg to -5 V (Id0  $\approx$  0 mA).
- 3. Set Vd to 0 V.
- 4. Turn off Vd.
- 5. Turn off Vg.



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